

# RSS070N05FRA

Nch 45V 7A Power MOSFET

## Datasheet

V <sub>DSS</sub>	45V
R <sub>DS(on)</sub> (Max.)	25mΩ
I <sub>D</sub>	±7.0A
P <sub>D</sub>	2.0W

## Features

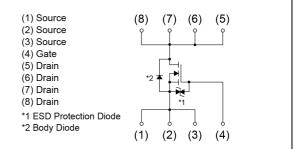
Application

Switching

- 1) Low on-resistance
- 2) Small Surface Mount Package (SOP8)
- 3) Pb-free lead plating ; RoHS compliant
- 4) AEC-Q101 Qualified

●Outline	(8)
SOP8	(1) (1) (2) (3) (4) (7) (6) (5) (5)

#### Inner circuit



## Packaging specifications

Туре	Packing	Embossed Tape
	Reel size (mm)	330
	Tape width (mm)	12
	Basic ordering unit (pcs)	2500
	Taping code	ТВ
	Marking	RSS070N05

## • Absolute maximum ratings (T<sub>a</sub> = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage	V <sub>DSS</sub>	45	V	
Continuous drain current	I <sub>D</sub>	±7.0	А	
Pulsed drain current	I <sub>DP</sub> *1	±28	А	
Gate - Source voltage	V <sub>GSS</sub>	±20	V	
Devien dia sin stien	P <sub>D</sub> *2	2.0	W	
Power dissipation	P <sub>D</sub> *3	1.4	W	
Junction temperature	Tj	150	°C	
Operating junction and storage temperature range	T <sub>stg</sub>	-55 to +150	°C	

## •Thermal resistance

Deremeter	Symbol -	Values			Linit
Parameter		Min.	Тур.	Max.	Unit
Thermal registeres innetion embient	$R_{thJA}^{*2}$	-	-	62.5	°C/W
Thermal resistance, junction - ambient	$R_{thJA}^{*3}$	-	-	89.2	°C/W

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Deverseter	Currente e l	Conditions	Values			L locit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA	45	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	I <sub>D</sub> = 1mA referenced to 25°C	-	46.8	-	mV/°C
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 45V, V <sub>GS</sub> = 0V	-	-	1	μA
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±20V, $V_{DS}$ = 0V	-	-	±10	μA
Gate threshold voltage	$V_{GS(th)}$	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	1.0	-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I <sub>D</sub> = 1mA referenced to 25°C	-	-3.9	-	mV/°C
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 7A	-	18	25	
Static drain - source on - state resistance	R <sub>DS(on)</sub> *4	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 7A	-	23	32	mΩ
		V <sub>GS</sub> = 4.0V, I <sub>D</sub> = 7A	-	25	35	
Gate resistance	R <sub>G</sub>	f = 1MHz, open drain	-	3.2	-	Ω
Forward Transfer Admittance	Y <sub>fs</sub>   <sup>*4</sup>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 7A	6.0	-	-	S

\*1 Pw $\leq$ 10µs, Duty cycle $\leq$ 1%

- \*2 Mounted on a ceramic board (30×30×0.8mm)
- \*3 Mounted on a FR4 (25×25×0.8mm)
- \*4 Pulsed



## • Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Sumpleal	Conditions		Linit			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	1000	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10V	-	230	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	125	-		
Turn - on delay time	t <sub>d(on)</sub> *4	$V_{DD} \simeq 25 V, V_{GS}$ = 10V	-	16	-		
Rise time	t <sub>r</sub> *4	I <sub>D</sub> = 3.5A	-	27	-	20	
Turn - off delay time	$t_{d(off)}^{*4}$	$R_L \simeq 7.1\Omega$	-	57	-	ns	
Fall time	t <sub>f</sub> *4	R <sub>G</sub> = 10Ω	-	21	-		

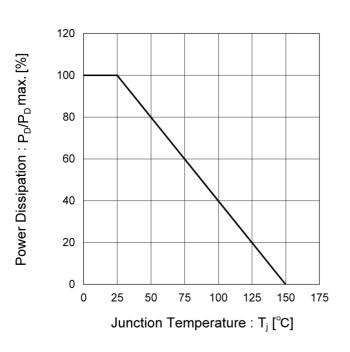
## • Gate charge characteristics ( $T_a = 25^{\circ}C$ )

Parameter	Symbol Conditions	Conditions	Values			Unit
		Conditions	Min.	Тур.	Max.	Unit
Total gate charge	$Q_g^{*4}$	V <sub>DD</sub> ≃ 25V,	-	12.0	16.8	
Gate - Source charge	Q <sub>gs</sub> *4	I <sub>D</sub> = 7A,	-	3.0	-	nC
Gate - Drain charge	${\sf Q}_{\sf gd}{}^{*4}$	V <sub>GS</sub> = 5V	-	4.6	-	

## •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Sympol	Conditions	Values			Unit
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ <sub>s</sub>	T - 25°0	-	-	1.6	А
Pulse forward current	I <sub>SP</sub> *1	T <sub>a</sub> = 25°C	-	-	28	А
Forward voltage	V <sub>SD</sub> *4	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.6A	-	-	1.2	V





## Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

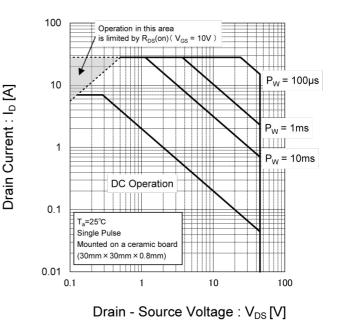
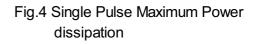
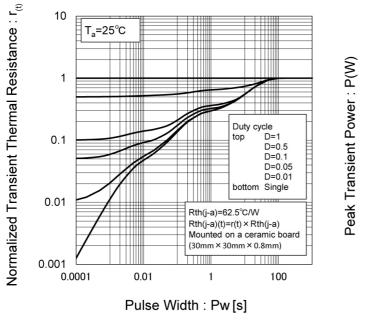


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width





Pulse Width : Pw [s]





#### Fig.5 Typical Output Characteristics(I)

V<sub>GS</sub>= 10V

V<sub>GS</sub>= 4.5V

V<sub>GS</sub>= 4.0V

V<sub>GS</sub>= 3.0V

V<sub>GS</sub>= 2.8V-

0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9

Drain - Source Voltage : V<sub>DS</sub> [V]

T<sub>a</sub>=25°C

V<sub>GS</sub>= 2.5V

V<sub>GS</sub>= 2.3V

Pulsed

Fig.6 Typical Output Characteristics(II)

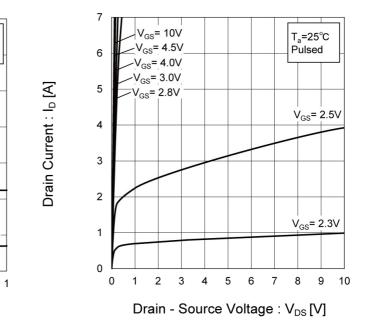
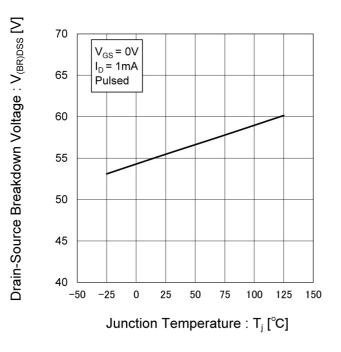
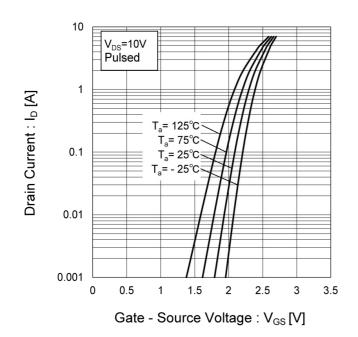


Fig.7 Breakdown Voltage vs. Junction Temperature

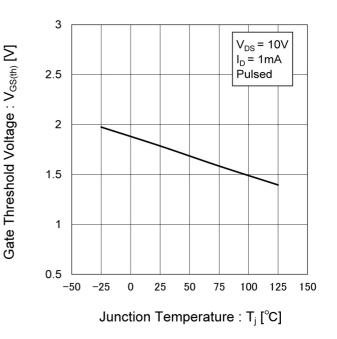




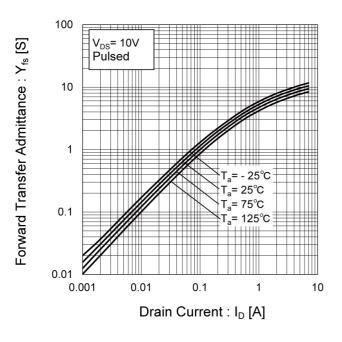


## Fig.8 Typical Transfer Characteristics

Fig.9 Gate Threshold Voltage vs. Junction Temperature



## Fig.10 Forward Transfer Admittance vs. Drain Current





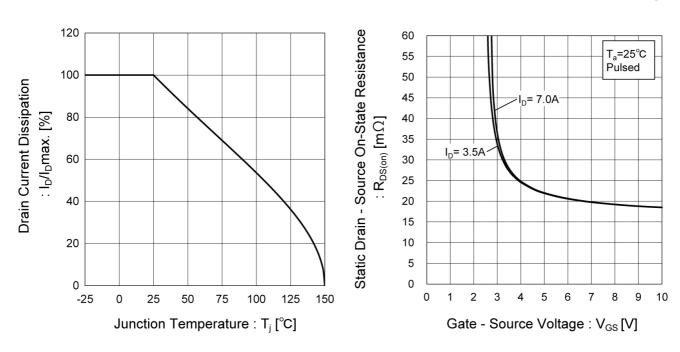
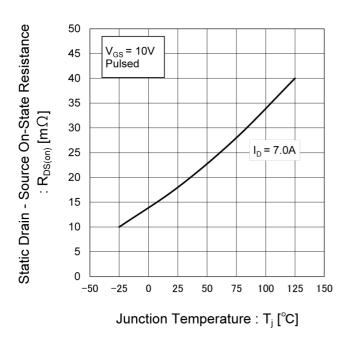


Fig.11 Drain Current Derating Curve

## Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature







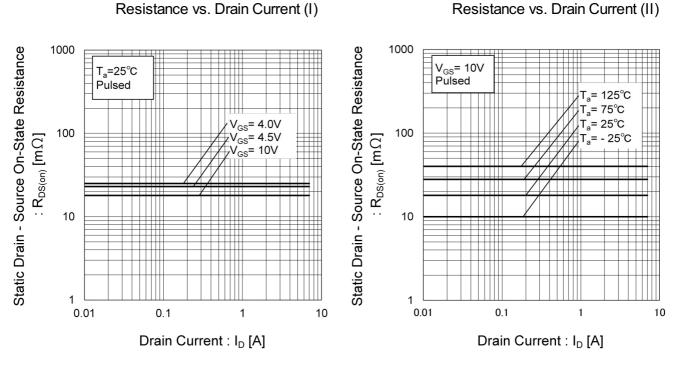


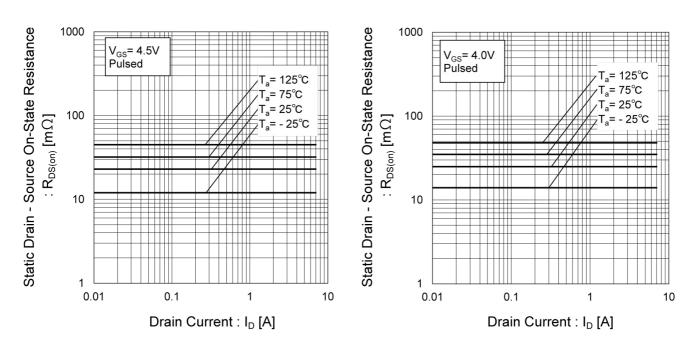
Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

Fig.16 Static Drain - Source On - State

Resistance vs. Drain Current (III)

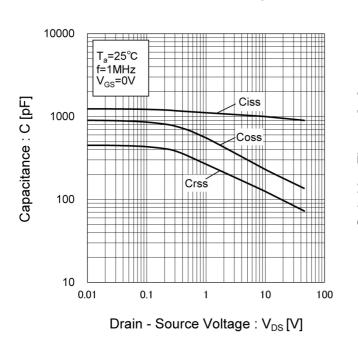
Fig.17 Static Drain - Source On - State Resistance vs. Drain Current (IV)

Fig.15 Static Drain - Source On - State



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### Fig.18 Typical Capacitance vs. Drain - Source Voltage

Fig.19 Switching Characteristics

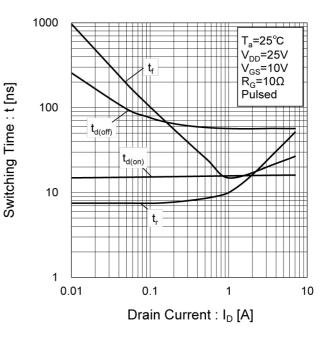


Fig.20 Dynamic Input Characteristics

Gate - Source Voltage : V<sub>GS</sub> [V]

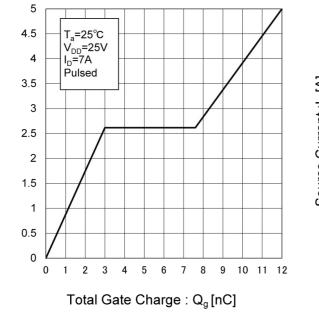
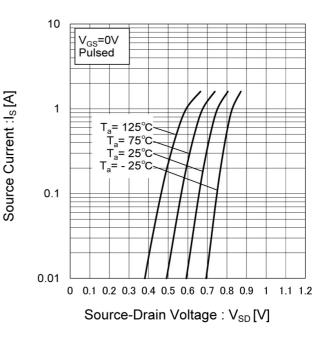


Fig.21 Source Current vs. Source Drain Voltage





#### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

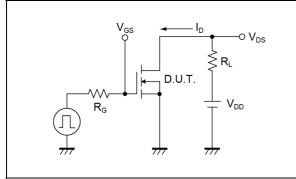


Fig.2-1 Gate Charge Measurement Circuit

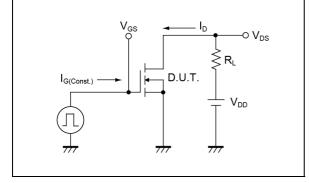
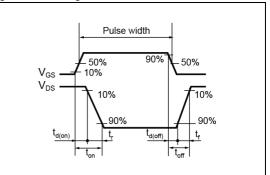
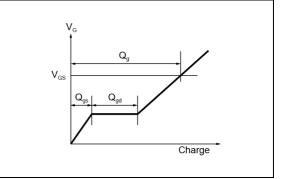


Fig.1-2 Switching Waveforms



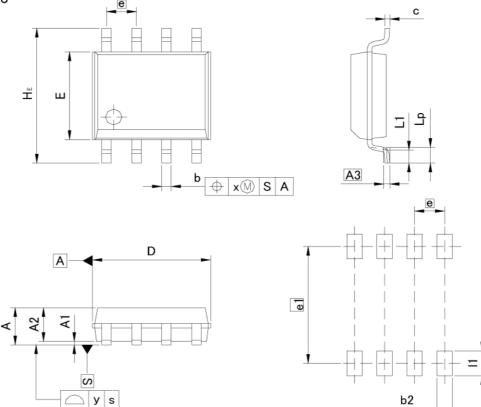






#### Dimensions

SOP8



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES		
DIM	MIN	MAX	MIN	MAX		
А	-	1.75	-	0.069		
A1	0.	15	0.0	06		
A2	1.40	1.60	0.055	0.063		
A3	0.3	25	0.0	10		
b	0.30	0.50	0.012	0.020		
с	0.10	0.30	0.004	0.012		
D	4.80	5.20	0.189	0.205		
E	3.75	4.05	0.148	0.159		
е	1.3	27	0.0	50		
HE	5.70	6.30	0.224	0.248		
L1	0.40	0.60	0.016	0.024		
Lp	0.65	0.85	0.026	0.033		
х	0.	15	0.006			
У	0.1	10	0.0	0.004		

DIM	MILIM	ETERS	INC	HES
MIN		MAX	MIN	MAX
b2	-	0.65	-	0.026
e1	5.	15	0.2	03
1	-	1.15	-	0.045

Dimension in mm/inches



# Notice

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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CLASSII	CLASSI	CLASS II b	CLASSⅢ
CLASSⅣ		CLASSⅢ	

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[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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